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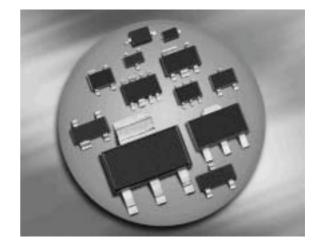




Silicon Tuning Diode

- High Q hyperabrupt tuning diode
- Designed for low tuning voltage operation for VCO's in mobile communications equipment
- For control elements as TCXOS and VCXOS
- High capacitance ratio and good C-V linearity
- Pb-free (RoHS compliant) package 1)
- Qualified according AEC Q101





BBY59-02V



Туре	Package	Configuration	L S(nH)	Marking
BBY59-02V	SC79	single	0.6	RR

Maximum Ratings at $T_A = 25$ °C, unless otherwise specified

	•		
Parameter	Symbol	Value	Unit
Diode reverse voltage	V_{R}	15	٧
Forward current	<i>I</i> _F	50	mA
Operating temperature range	T_{op}	-55 150	°C
Storage temperature	$T_{\rm stg}$	-55 150	

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¹Pb-containing package may be available upon special request



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

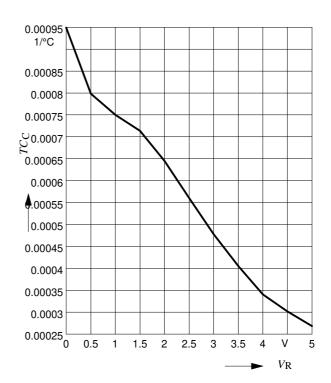
Parameter	Symbol		Values		
		min.	nin. typ.		1
DC Characteristics					
Reverse current	l _R				nA
<i>V</i> _R = 10 V		-	-	20	
$V_{R} = 10 \text{ V}, T_{A} = 85 ^{\circ}\text{C}$		-	-	100	
AC Characteristics					
Diode capacitance	C_{T}				рF
$V_{R} = 1 \text{ V}, f = 1 \text{ MHz}$		26,6	27.8	29	
$V_{R} = 2 \text{ V}, f = 1 \text{ MHz}$		13.6	15.3	17	
$V_{R} = 3 \text{ V}, f = 1 \text{ MHz}$		8,4	9.5	10.9	
$V_{R} = 4 \text{ V}, f = 1 \text{ MHz}$		6,1	6,95	7,8	
Capacitance ratio	C_{T1}/C_{T4}	3,4	4	4,6	
$V_{R} = 1 \text{ V}, \ V_{R} = 4 \text{ V}$					
Series resistance	r _S	-	0.45	0.7	Ω
$V_{\rm B} = 1 \text{ V}, f = 470 \text{ MHz}$					



Diode capacitance $C_T = f(V_R)$ f = 1MHz

pF 50 45 40 C_{T} 35 30 25 20 15 10 5₀ 0.5 1.5 2.5 ٧ $V_{\rm R}$

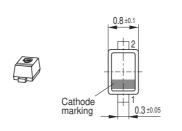
Temperature coefficient of the diode capacitance $T_{Cc} = f(V_R)$

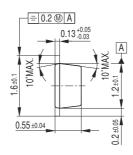


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Package Outline

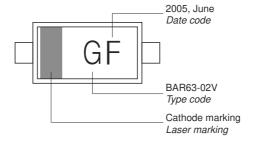




Foot Print



Marking Layout (Example)

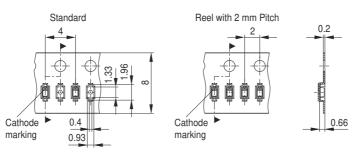


Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel

Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)

Reel ø330 mm = 10.000 Pieces/Reel



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Date Code marking for discrete packages with one digit (SCD80, SC79, SC751) CES-Code

Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	а	р	Α	Р	а	р	Α	Р	а	р	Α	Р
02	b	q	В	Q	b	q	В	Q	b	q	В	Q
03	С	r	С	R	С	r	С	R	С	r	С	R
04	d	S	D	S	d	S	D	S	d	S	D	S
05	е	t	Е	T	е	t	Е	Т	е	t	Е	Т
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	V	G	٧	g	٧	G	٧	g	٧	G	V
08	h	Х	Η	Χ	h	Х	Н	Χ	h	Х	Η	X
09	j	у	7	Υ	j	у	7	Υ	j	у	J	Υ
10	k	Z	K	Z	k	Z	K	Z	k	Z	K	Z
11	I	2	L	4	İ	2	L	4	İ	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

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¹⁾ New Marking Layout for SC75, implemented at October 2005.



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